

## LNPTM THERMOCOMPTM COMPOUND RF0069S

RF-1006 FR HS

## **DESCRIPTION**

Consumer

Industrial

Electrical and Electronics

LNP THERMOCOMP RF0069S compound is based on Nylon 6/6 resin containing 30% glass fiber. Added features of this grade include: Flame Retardant, Heat Stabilized.

GENERAL INFORMATION	
Features	Flame Retardant, Heat Stabilized, High stiffness/Strength, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyamide 66 (Nylon 66)
Processing Techniques	Injection Molding
INDUSTRY	SUB INDUSTRY
Automotive	Automotive Interiors
Building and Construction	Building Component

## TYPICAL PROPERTY VALUES Revision 20231109

Electrical

Mobile Phone - Computer - Tablets

Sport/Leisure, Personal Accessory, Home Appliances, Commercial Appliance

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL (1)			
Tensile Stress, break	165	MPa	ASTM D638
Tensile Strain, break	2.7	%	ASTM D638
Flexural Stress	240	MPa	ASTM D790
Flexural Modulus	12200	MPa	ASTM D790
IMPACT (1)			
Izod Impact, unnotched, 23°C	694	J/m	ASTM D4812
Izod Impact, notched, 23°C	74	J/m	ASTM D256
THERMAL (1)			
Relative Temp Index, Elec (2)	130	°C	UL 746B
Relative Temp Index, Mech w/impact (2)	105	°C	UL 746B
Relative Temp Index, Mech w/o impact (2)	115	°C	UL 746B
PHYSICAL (1)			
Density	1.71	g/cm³	ASTM D792
Mold Shrinkage, flow, 24 hrs <sup>(3)</sup>	0.3	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs <sup>(3)</sup>	1	%	ASTM D955
ELECTRICAL (1)			
Comparative Tracking Index (UL) {PLC}	3	PLC Code	UL 746A
Hot-Wire Ignition (HWI), PLC 0	≥1.7	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 0	≥1.7	mm	UL 746A
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PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
High Voltage Arc Track Rate {PLC}	1	PLC Code	UL 746A
Arc Resistance, Tungsten {PLC}	7	PLC Code	ASTM D495
FLAME CHARACTERISTICS (2)			
UL Yellow Card Link	E121562-101281595	-	-
UL Yellow Card Link 2	E207780-101281608	-	-
UL Recognized, 94V-0 Flame Class Rating	≥0.75	mm	UL 94
INJECTION MOLDING (4)			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.15 – 0.25	%	
Melt Temperature	275 – 290	°C	
Front - Zone 3 Temperature	295 – 305	°C	
Middle - Zone 2 Temperature	280 – 295	°C	
Rear - Zone 1 Temperature	265 – 275	°C	
Mold Temperature	80 – 95	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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